

Electronic Patent Application Fee Transmittal

Application Number:	10055266			
Filing Date:	22-Jan-2002			
Title of Invention:	SEMICONDUCTOR PACKAGE HAVING CHANGED SUBSTRATE DESIGN USING SPECIAL WIRE BONDING			
First Named Inventor/Applicant Name:	Ki-won Choi			
Filer:	Alexander Charles Johnson/Li mei Vermilya			
Attorney Docket Number:	9898-208			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Publ. Fee- early, voluntary, or normal	1504	1	300	300
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	1501	1	1440	1440

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				1740